### Innovating Energy Technology

# FMV60N133S2FDHF

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**FUJI POWER MOSFET** 

## Super J MOS® S2 series

### N-Channel enhancement mode power MOSFET

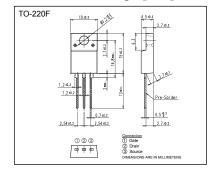
#### Features

Pb-free lead terminal RoHS compliant uses Halogen-free molding compound

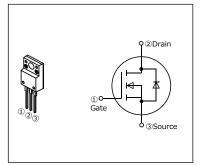
### Applications

For switching

### Outline Drawings [mm]



### Equivalent circuit schematic



### ■ Absolute Maximum Ratings at T<sub>vi</sub>=25°C (unless otherwise specified)

| Parameter                                   | Symbol                 | Characteristics | Unit  | Remarks                               |
|---|------------------------|-----------------|-------|---------------------------------------|
| Drain Source Voltage                        | V <sub>DS</sub>        | 600             | V     |                                       |
| Drain-Source Voltage                        | V <sub>DSX</sub>       | 600             | V     | V <sub>GS</sub> =-30V                 |
| Continuous Drain Current                    | Io                     | 30.1            | Α     | <i>T</i> <sub>vj</sub> =25°C Note*1,2 |
| Continuous Drain Current                    |                        | 19              | Α     | T <sub>vj</sub> =100°C Note*1,2       |
| Pulsed Drain Current                        | <b>I</b> DP            | 90.8            | Α     | Note *2                               |
| Gate-Source Voltage                         | <b>V</b> <sub>GS</sub> | ±30             | V     |                                       |
| Non-Repetitive<br>Maximum Avalanche Current | I <sub>AS</sub>        | 3.5             | Α     | Note *3                               |
| Non-Repetitive<br>Maximum Avalanche Energy  | Eas                    | 748             | mJ    | Note *4                               |
| Maximum Drain-Source dV/dt                  | d <i>V</i> ⊳s/dt       | 50              | V/ns  | V <sub>DS</sub> ≤ 600V                |
| Continuous                                  | ,                      | 30.1            | Α     | T <sub>vj</sub> =25°C Note*1,2        |
| Diode Forward Current                       | <b>I</b> sD            | 19              | Α     | T <sub>vj</sub> =100°C Note*1,2       |
| Pulsed Diode Forward Current                | <b>I</b> SDP           | 90.8            | Α     | Note *2                               |
| Peak Diode Recovery dV/dt                   | dV/dt                  | 30              | V/ns  | Note *5                               |
| Peak Diode Recovery -di/dt                  | -di/dt                 | 100             | A/µs  | Note *6                               |
| Maximum Bower Discination                   | P□                     | 2.16            | W     | T <sub>a</sub> =25°C                  |
| Maximum Power Dissipation                   | <b>7</b> D             | 57              | VV    | T <sub>vj</sub> =25°C                 |
| Operating and Storage Temperature range     | <b>T</b> ch            | 150             | °C    |                                       |
|   | <b>T</b> stg           | -55 to +150     | °C    |                                       |
| Isolation Voltage (TO-220F)                 | V <sub>iso</sub>       | 2               | kVrms | t=60sec,f=60Hz                        |

Note \*1 : Maximum duty cycle D=0.57

Note \*1: Maximum duty cycle D=U.57Note \*2: Limited by maximum channel temperature. Note \*3:  $T_{ch} \le 150^{\circ}$ C, See Fig.1 and Fig.2 Note \*4: Starting  $T_{ch} = 25^{\circ}$ C,  $I_{as} = 2.1A$ ,  $I_{ch} = 311$ mH,  $V_{DD} = 60V$ ,  $R_{G} = 50\Omega$ , See Fig.1 and Fig.2  $E_{AS}$  limited by maximum channel temperature and avalanche current. Note \*5:  $I_{SD} \le 22.7A$ ,  $-di/dt \le 100A/\mu s$ ,  $V_{DS}$   $I_{Peak} \le 600V$ ,  $T_{ch} \le 150^{\circ}$ C. Note \*6:  $I_{SD} \le 22.7A$ ,  $dV/dt \le 30V/ns$ ,  $V_{DS}$   $I_{Peak} \le 600V$ ,  $T_{ch} \le 150^{\circ}$ C.

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# ■ Electrical Characteristics at *T*<sub>vj</sub>=25°C (unless otherwise specified) • Static Ratings

| Parameter                        | Symbol                   | Conditions  |                               | Min. | Тур.  | Max.  | Unit |
|----------------------------------|--------------------------|---|-------------------------------|------|-------|-------|------|
| Drain-Source Breakdown Voltage   | <b>BV</b> <sub>DSS</sub> | V <sub>ss</sub> =0V<br>I <sub>b</sub> =250μA              |                               | 600  | -     | -     | V    |
| Gate Threshold Voltage           | V <sub>GS(th)</sub>      | V <sub>DS</sub> =V <sub>GS</sub><br>I <sub>D</sub> =3.5mA |                               | 3.0  | 4.0   | 5.0   | V    |
| Zero Gate Voltage Drain Current  | <b>I</b> bss             | V <sub>DS</sub> =600V<br>V <sub>GS</sub> =0V              | T <sub>ch</sub> =25°C         | -    | -     | 25    | μΑ   |
|                                  |                          | V <sub>DS</sub> =480V<br>V <sub>GS</sub> =0V              | <i>T</i> <sub>ch</sub> =125°C | -    | 36    | -     |      |
| Gate-Source Leakage Current      | <b>I</b> GSS             | V <sub>DS</sub> =0V<br>V <sub>GS</sub> = ± 30V            |                               | -    | 10    | 100   | nA   |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub>      | V <sub>GS</sub> =10V<br>I <sub>D</sub> =11.4A             |                               | -    | 0.117 | 0.133 | Ω    |
| Gate resistance                  | <b>R</b> <sub>G</sub>    | f=1MHz, open drain  |                               | -    | 8.3   | -     | Ω    |

### Dynamic Ratings

| Parameter  | Symbol                 | Conditions  | Min. | Тур. | Max. | Unit       |
|--|------------------------|---|------|------|------|------------|
| Forward Transconductance                               | <b>G</b> fs            | V <sub>DS</sub> =25V<br>I <sub>D</sub> =11.4A   | 7.5  | 15   | -    | S          |
| Input Capacitance                                      | Ciss                   | V <sub>DS</sub> =400V   | -    | 1190 | -    |            |
| Output Capacitance                                     | Coss                   | V <sub>GS</sub> =0V   | -    | 42   | -    |            |
| Reverse Transfer Capacitance                           | Crss                   | f=250kHz  | -    | 5.8  | -    |            |
| Effective output capacitance, energy related (Note *7) | C <sub>o(er)</sub>     | V <sub>DS</sub> =0400V<br>V <sub>GS</sub> =0V   | -    | 103  | -    | pF         |
| Effective output capacitance, time related (Note *8)   | C <sub>o(tr)</sub>     | V <sub>DS</sub> =0400V<br>V <sub>GS</sub> =0V<br>J <sub>D</sub> =constant                                       | -    | 410  | -    |            |
| Turn-On Time   | t <sub>d(on)</sub>     | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V<br>$I_{\rm D}$ =11.4A,<br>$R_{\rm G}$ =15 $\Omega$<br>See Fig.3 and Fig.4 | -    | 20   | -    |            |
| Turn-On Time   |                        |   | -    | 65   | -    |            |
| Turn-Off Time  | t <sub>d(off)</sub>    |   | -    | 131  | -    | ns         |
|  | <b>t</b> f             |   | -    | 23   | -    |            |
| Total Gate Charge                                      | <b>Q</b> <sub>G</sub>  | V <sub>DD</sub> =400V, V <sub>GS</sub> =10V<br>I <sub>D</sub> =22.7A<br>See Fig.5                               | -    | 59   | -    |            |
| Gate-Source Charge                                     | <b>Q</b> <sub>GS</sub> |   | -    | 20   | -    | <b>~</b> C |
| Gate-Drain Charge                                      | <b>Q</b> <sub>GD</sub> |   | -    | 27   | -    | nC         |
| Drain-Source crossover Charge                          | <b>Q</b> sw            |   | -    | 13   | -    |            |

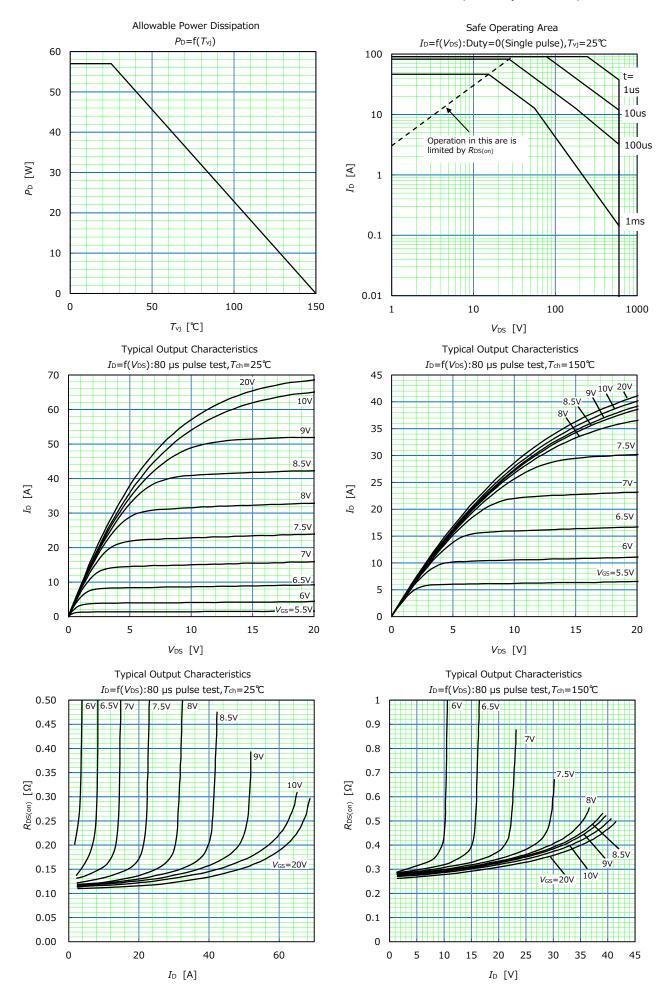
Note  $^*7$ :  $C_{0(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 400V. Note  $^*8$ :  $C_{0(fr)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 400V.

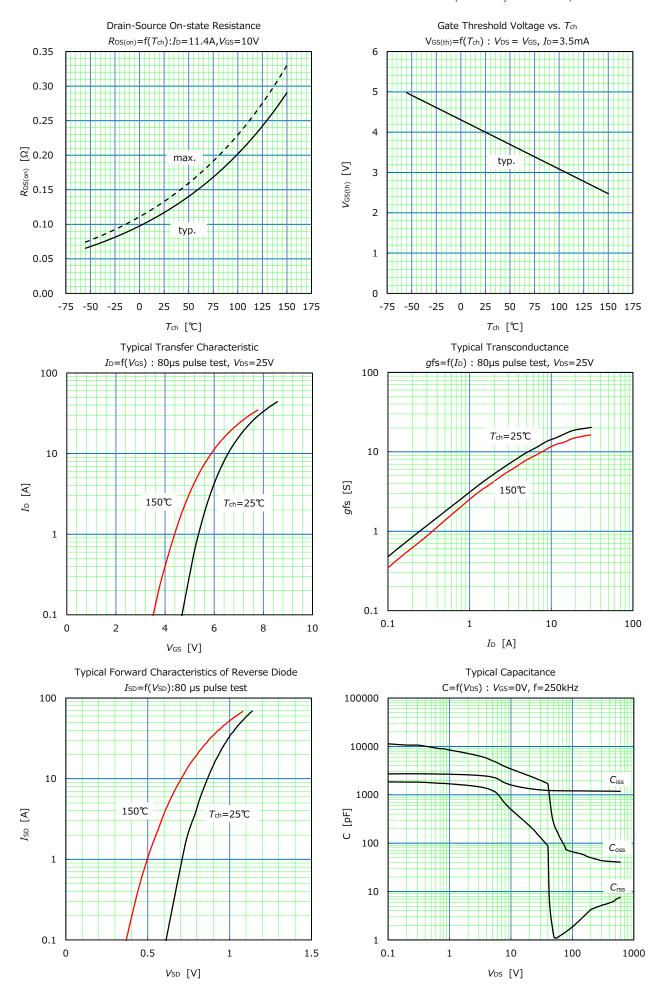
### • Reverse Diode

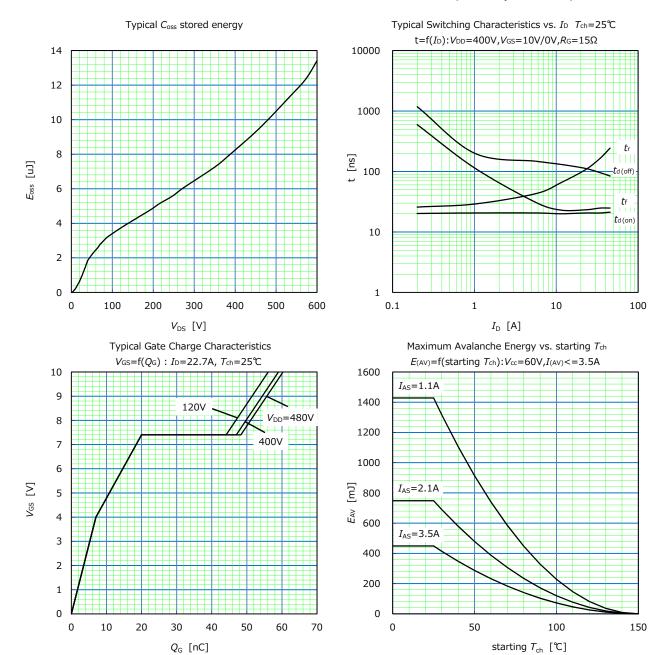
| Parameter                     | Symbol                 | Conditions  | Min. | Тур. | Max. | Unit |
|-------------------------------|------------------------|---|------|------|------|------|
| Diode Forward On-Voltage      | <b>V</b> <sub>SD</sub> | I <sub>SD</sub> =22.7A, V <sub>GS</sub> =0V<br>T <sub>ch</sub> =25°C  | -    | 0.95 | 1.35 | V    |
| Reverse Recovery Time         | <b>t</b> rr            | - V <sub>DD</sub> =400V, I <sub>SD</sub> =22.7A<br>-di/dt=100A/μs<br>T <sub>ch</sub> =25°C<br>See Fig.6 and Fig.7 | -    | 160  | -    | ns   |
| Reverse Recovery Charge       | Qrr                    |   | -    | 1.2  | -    | μC   |
| Peak Reverse Recovery Current | <b>I</b> rp            |   | -    | 14.5 | -    | Α    |

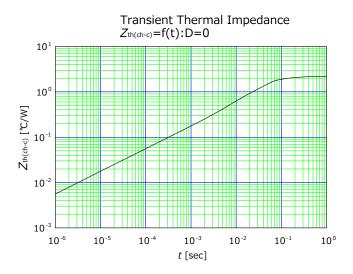
### ■ Thermal Resistance

| Parameter          | Symbol                | Min. | Тур. | Max.  | Unit |
|--------------------|-----------------------|------|------|-------|------|
| Channel to Case    | R <sub>th(ch-c)</sub> | -    | -    | 2.193 | °C/W |
| Channel to Ambient | R <sub>th(ch-a)</sub> | -    | -    | 58    | °C/W |









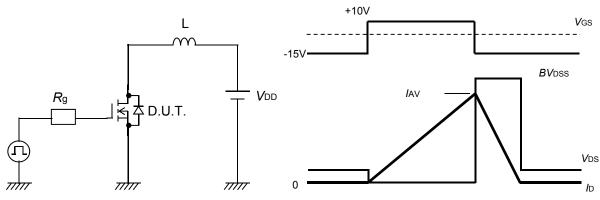


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

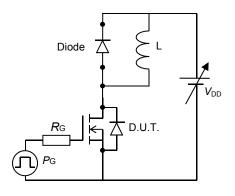


Fig.3 Switching Test circuit

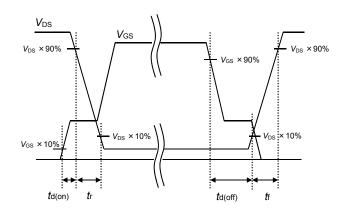


Fig.4 Operating waveform of Switching Test

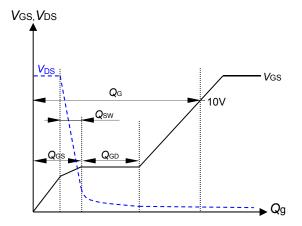


Fig.5 Operating waveform of Gate charge Test

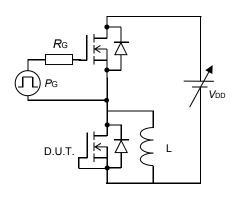


Fig.6 Reverse recovery Test circuit

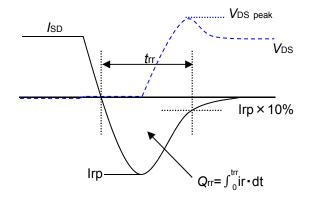
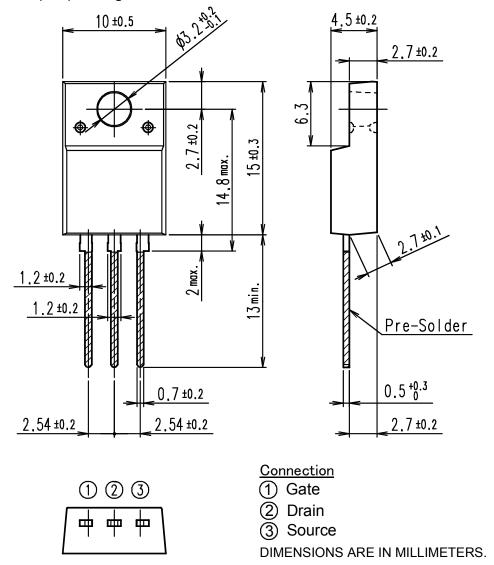
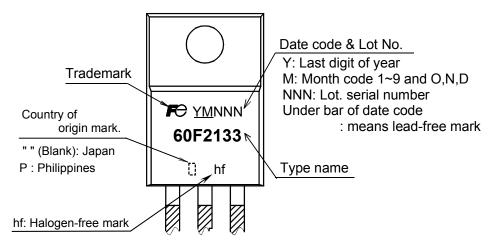


Fig.7 Operating waveform of Reverse recovery Test

### Outview: TO-220F(SLS) Package



### Marking



<sup>\*</sup> The font (font type,size) and the trademark-size might be actually different.

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